## RoHS Compliant

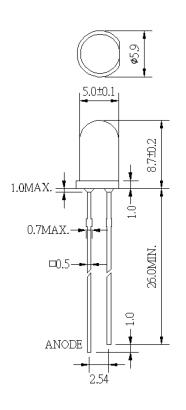


#### **Features**

Dice Material : AlInGaP
Peak Wave Length (nm) : 653
Emitted Colour : Super Red
Viewing Angle (deg) : 45

Lens Colour : Red Diffused

IV (mcd) : 180



## Electrical / Optical Characteristics at Ta = 25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test	
Luminous Intensity	IV	120	180	250	mcd	IF = 20mA	
Viewing Angle	201/2		45		deg		
Peak Emission Wavelength	λр		653		nm		
Dominant Wavelength	λD	632	637	643	nm		
Spectral Line Half-Width	Δλ		19		nm		
Forward Voltage	VF	1.7	1.9	2.4	V		
Power Dissipation	Pd	-	-	85	mW		
Peak Forward current (Duty1/10@ 1KHz)	IF (Peak)			100	mA		
Recommended Operating Current	IF (Rec)			30	mA		

## Absolute Maximum Ratings: ( Ta = 25°C)

Reverse Voltage : 5 Volt

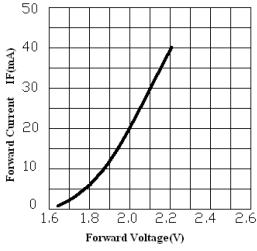
Reverse Current : 10 uA (VR = 5V)Operating Temperature Range :  $-40^{\circ}\text{C to } +85^{\circ}\text{C}$ Storage Temperature Range :  $-40^{\circ}\text{C to } +100^{\circ}\text{C}$ Lead Soldering Temperature Range :  $260^{\circ}\text{C for 5 sec.}$ 

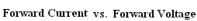
(1.6 mm (1/16 inch) from body)

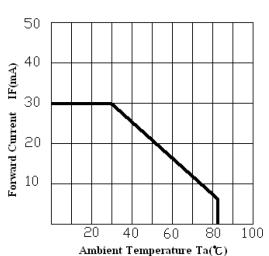
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## **Typical Electro-Optical Characteristics Curves**

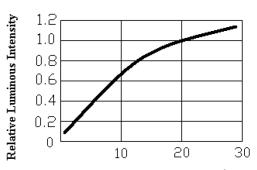
Ultra Red(AlInGaP \(\lambda\)P=653nm)



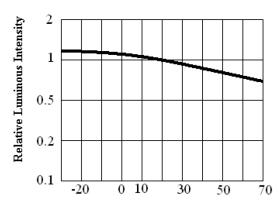




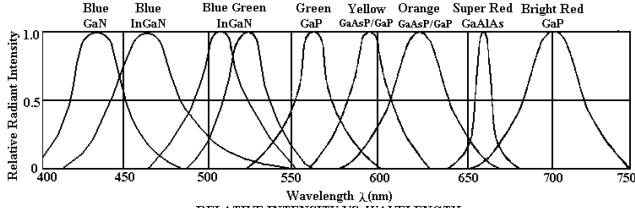
Forward Current Derating Curve



Forward current (mA) Ta=25°C Luminous Intensity vs. Forward current



 $\label{eq:ambient} \begin{tabular}{ll} Ambient\ Temperature\ Ta=\ ^{\circ}C \\ Luminous\ Intensity\ vs.\ Ambient\ Temperature \\ \end{tabular}$ 



RELATIVE INTENSITY VS. WAVELENGTH

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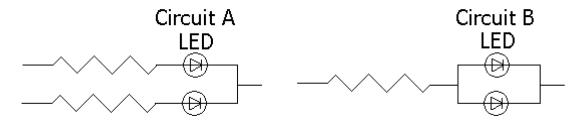
## **Reliability Test**

NO.	Item	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25°C IF:20mA			
2	High Temperature High Humidity	Temperature:85°C 85%RH	1000 HRS		
3	High Temperature Storage	Temperature:100°C	erature:100°C		
4	Low Temperature Storage	Temperature:-40°C		20 PCS	0/1
5	Temperature Cycling	85°C~ 25°C~-35°C 15min~ 5min~ 15min	15 Cycles		
6	Thermal Shock	85°C~ 25°C~-10°C 5min~ 10sec~ 5min	15 Cycles		
7	Solder Heat	Temperature:260°C±5°C	10 sec.		

### **Precautions for Using LED**

#### 1. Drive Method

LED is current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit



(a) Circuit A: it is recommended circuit.

(b) Circuit B: the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

#### 2. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 3. Storage

The Storage Temperature and RH are: 5°C ~ 30°C, RH 60% or less.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in moisture proof package with moisture absorbent material (silica gel).

We suggest our customers to use the products within a year.

If the moisture absorbent material (silica gel) has faded or the LEDs exceeded the storage time, baking treatment should be performed using the following conditions:

Baking treatment: more than 24 hours at 60°C ±5°C.



#### 4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs Suggestions to prevent ESD damage:

Use of a conductive wrist band or ante-electrostatic glove while handing the LEDs.

All devices, equipment, and machinery must be properly grounded.

Work tables storage racks, etc. should be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

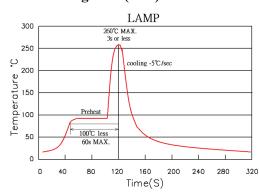
#### 5. Others

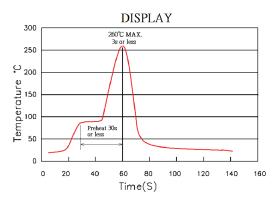
- (a) If you want to have the uniform luminance and Colour, please use the same binning number, and components from mixed bins will cause the differences of luminance and Colours.
- (b) The appearance and specifications of the product may be modified for improvement without prior notice.

#### 6. Soldering

Recommended soldering condition as shown below:

## • Soldering heat (DIP)



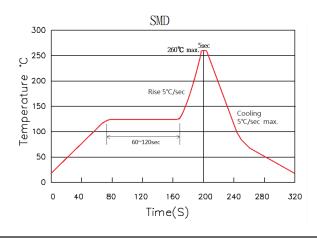


#### Soldering Iron

Temperature at tip of iron: 350°C Max.

Soldering Time:  $3 \text{ sec.} \pm 1 \text{ sec.}$  (one time only) If temperature is higher, time should be shorter.

#### • Reflow Temp./Time (SMD)



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### **Part Number Table**

Description	Part Number	
5mm Round LED, Red, 653nm, 45°, 180mcd, Through hole	MP006837	

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Page <5> 09/02/21 V1.0